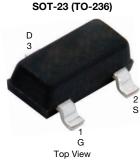
Si2392BDS

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Marking code: H1

PRODUCT SUMMARY					
V _{DS} (V)	100				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.149				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.180				
Q _g typ. (nC)	2.2				
I _D (A) ^a	2.3				
Configuration	Single				

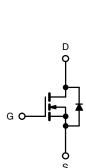
FEATURES

N-Channel 100 V (D-S) MOSFET

- TrenchFET[®] Gen IV power MOSFET
- 100 % $\rm R_g$ and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- DC/DC converters / boost converters
- · Load switch
- LED backlighting in LCD TVs
- · Power management for mobile computing



N-Channel MOSFET

ORDERING INFORMATION

Package	SOT-23
Lead (Pb)-free and halogen-free	Si2392BDS-T1-GE3
Alternate manufacturing location	Si2392BDS-T1-BE3

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	100	V	
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		2.3		
	T _C = 70 °C		1.8		
	T _A = 25 °C	ID	2.0 ^{b, c}		
	T _A = 70 °C		1.6 ^{b, c}	•	
Pulsed drain current (t = 300 µs)		I _{DM}	6	— A	
Continuous courses drain diada current	T _C = 25 °C	I _S	1.4		
Continuous source-drain diode current	T _A = 25 °C		1 b, c		
Single pulse avalanche current		I _{AS}	4		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	0.8	mJ	
Maximum power dissipation	T _C = 25 °C	P _D	1.7		
	T _C = 70 °C		1.1	14/	
	T _A = 25 °C		1.25 ^{b, c}	- W	
	T _A = 70 °C	_	0.8 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R _{thJA}	75	100	°C/W	
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	40	75	0/10	

Notes

a. Based on $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. Maximum under steady state conditions is 166 °C/W

S24-0815-Rev. C, 19-Aug-2024

1

Pb-free

RoHS

COMPLIANT

HALOGEN

FREE

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	100	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D =10 mA	-	80	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2	-	3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current	I _{DSS}	V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 55 °C	-	-	10	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	3	-	-	А	
	_	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2 \text{ A}$	-	0.124	0.149	0	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 1 A	-	0.138	0.180	Ω	
Forward transconductance ^a	g _{fs}	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 2 \text{ A}$	-	12	-	S	
Dynamic ^b	• •			•			
Input capacitance	C _{iss}		-	290	-	pF	
Output capacitance	C _{oss}	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz	-	26	-		
Reverse transfer capacitance	C _{rss}		-	5	-		
		$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$	-	4.7	7.1		
Total gate charge	Qg		-	2.2	3.3	- nC	
Gate-source charge	Q _{qs}	V_{DS} = 50 V, V_{GS} = 4.5 V, I_{D} = 0.5 A	-	1	-		
Gate-drain charge	Q _{ad}		-	0.5	-		
Gate resistance	Ra	f = 1 MHz	0.3	1.5	3	Ω	
Turn-on delay time	t _{d(on)}		-	15	30		
Rise time	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{L}} = 31.25 \Omega$	-	15	30	1	
Turn-off delay time	t _{d(off)}	$I_D = 1.6 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{ R}_g = 1 \Omega$	-	13	26		
Fall time	t _f		-	8	16		
Turn-on delay time	t _{d(on)}	$V_{DD} = 50 \text{ V}, \text{ R}_{\text{L}} = 31.25 \ \Omega$ $\text{I}_{\text{D}} = 1.6 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \ \Omega$	-	8	16	ns	
Rise time	t _r		-	5	10	-	
Turn-off delay time	t _{d(off)}		-	15	30		
Fall time	t _f		-	5	10		
Drain-Source Body Diode Characteristi	cs				1		
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	1.4		
Pulse diode forward current ^a	I _{SM}	-	-	-	6	A	
Body diode voltage	V _{SD}	I _S = 1.6 A	-	0.8	1.2	V	
Body diode reverse recovery time	t _{rr}	-	-	21	32	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 1.6 A, di/dt = 100 A/μs,	_	21	32	nC	
Reverse recovery fall time	t _a	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	19	-	1	
2	u u			l		ns	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

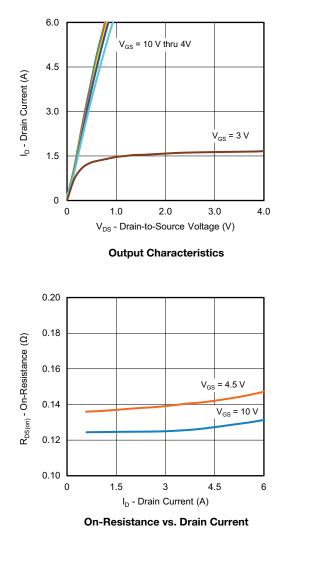
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

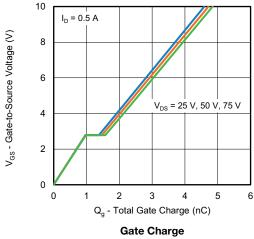
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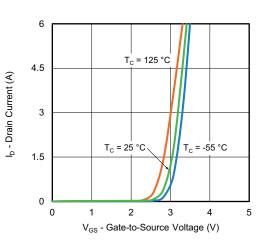


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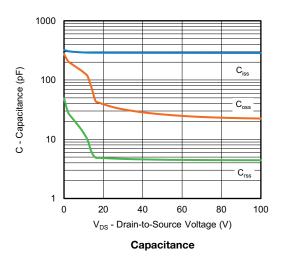
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

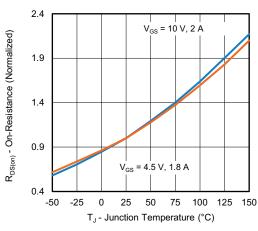






Transfer Characteristics





On-Resistance vs. Junction Temperature

S24-0815-Rev. C, 19-Aug-2024

3

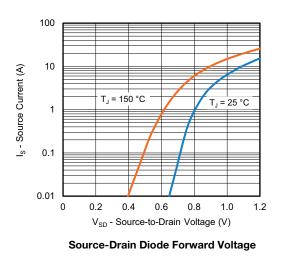
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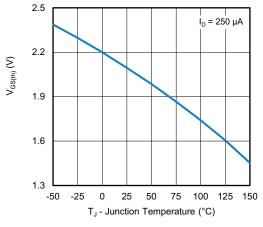


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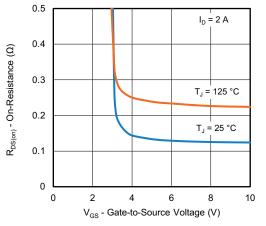
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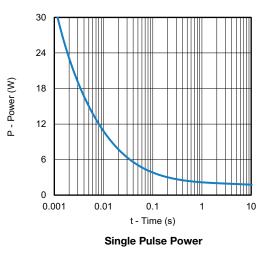


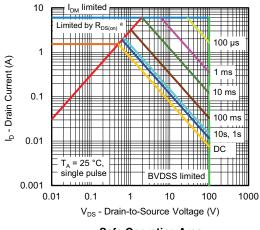






On-Resistance vs. Gate-to-Source Voltage







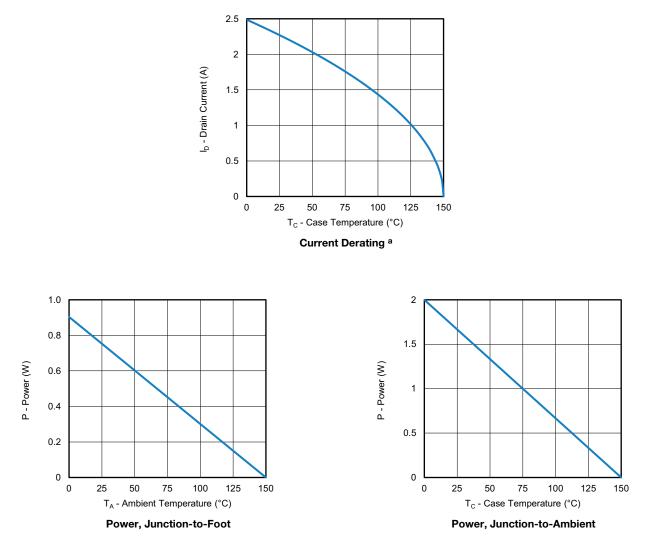
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

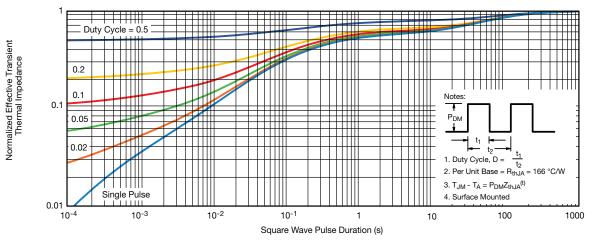
a. The power dissipation P_D is based on T_J max.= 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



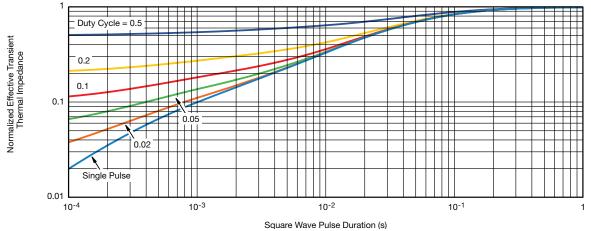
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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1